

# **Driver for Digital Still Camera**

# 1-2ch Lens Drivers for SLRs (Single-lens Reflex)



#### **BD65499MUV**

# General Description

The BD65499MUV motor driver provides built—in boost converter and 1ch H-bridge FULL ON driver. Integrated boost converter for high voltage and large current H-bridge, especially designed for mobile system piezoelectric element with a compact surface mount package.

#### Features

- Low ON resistance DMOS output
- DC/DC boost converter
- Output switching speed changeability (DC/DC converter: 4 step, H-bridge: 2 step)
- Charge pump less as using Pch DMOS for high-side output (H-bridge)
- Control input terminal available with 1.8V
- With built-in Under Voltage Locked Out protection, Thermal Shut Down, and Over Current Protection circuit

#### Applications

- Small mobile system
- Home appliance
- Amusement system, etc

#### Key Specifications

Power supply voltage (V<sub>CC</sub>): 2.7 to 3.6V Motor power supply voltage (V<sub>P</sub>): 4.0 to 27.0V Circuit current: 2.8mA(Typ.) Stand-by current: 1μA (Max.) Control input voltage: 0 to V<sub>CC</sub> V 300kHz(Max.) Control input frequency: Serial clock input frequency: 5MHz(Max.) Turn On time: 150ns(Typ.) Turn Off time: 50ns(Typ.) H-bridge output current (DC): 500mA Motor voltage supply output current (DC): 300mA DC/DC converter switching frequency: 750kHz(Typ.)

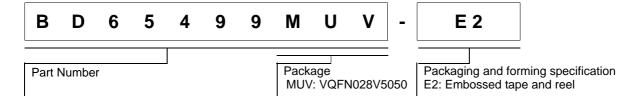
Output ON resistance

DC/DC converter Nch. DMOS: 0.20Ω(Typ.)
 H-bridge (total): 0.60Ω(Typ.)
 Operating temperature range: -30 to 85°C

●Package VQFN028V5050 W(Typ.) x D(Typ.) x H(Max.) 5.00mm x 5.00mm x 1.00mm



#### Ordering Information



# Block Diagram / Application Example

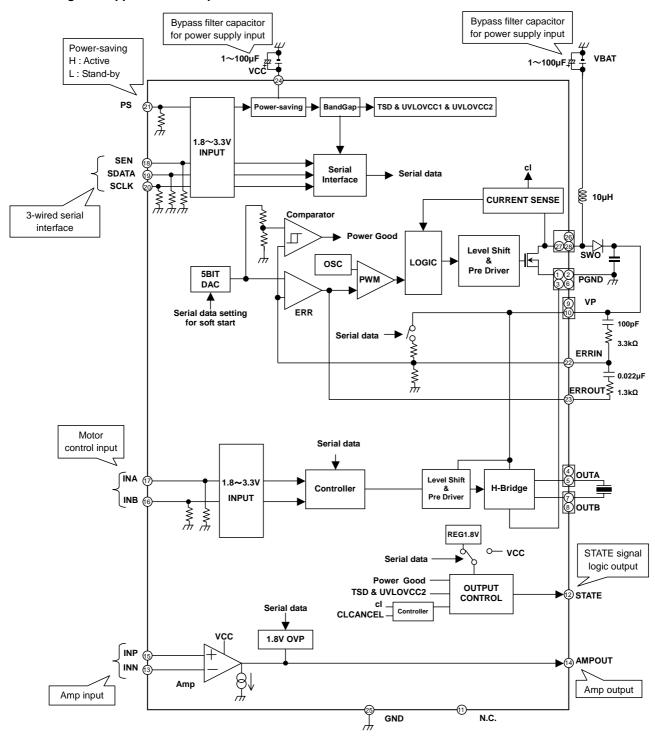


Figure 1. Block diagram

# ●Pin Configuration

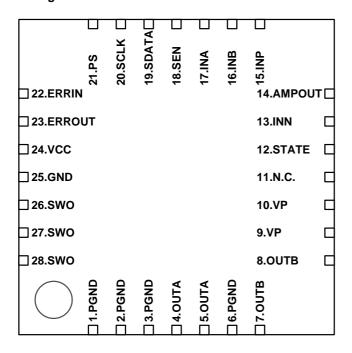


Figure 2. Pin Configuration (Top View)

# Pin Description

Pin No.	Terminal	Function	PS=Lo condition
25	GND	Ground terminal	-
1,2,3,6	PGND	Power ground terminal	-
24	VCC	Small signal power supply terminal	-
11	N.C.	N.C.	-
9,10	VP	VP power supply terminal	-
26,27,28	SWO	Nch power FET output terminal	HiZ
4,5	OUTA	H-bridge output terminal ch.A	HiZ
7,8	OUTB	H-bridge output terminal ch.B	HiZ
17	INA	Control input terminal A	Lo
16	INB	Control input terminal B	Lo
12	STATE	STATE output terminal	Lo
15	INP	Amp plus input terminal	HiZ
13	INN	Amp minus input terminal	HiZ
14	AMPOUT	Buffer Amp output terminal	HiZ
22	ERRIN	Error Amp input terminal	Lo
23	ERROUT	Error Amp output terminal	Lo
21	PS	Power-saving terminal	Lo
18	SEN	3-wired serial enable input terminal	Lo
19	SDATA	3-wired serial data input terminal	Lo
20	SCLK	3-wired serial clock input terminal	Lo

<sup>\*</sup> Short-circuit on an implementation pattern about the following each of the same terminal name. Power ground (PGND), VP power supply terminal (VP), Nch power FET output terminal (SWO), H-bridge output terminal ch.A (OUTA), H-bridge output terminal ch.B (OUTB).

# ■Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Power supply voltage	V <sub>CC</sub>	-0.3 to +4.5	V
VP Power supply voltage	$V_P$	-0.3 to +30.0	V
SWO supply voltage	V <sub>SWO</sub>	-0.3 to +30.0	V
Control input voltage	V <sub>IN</sub>	-0.3 to V <sub>CC</sub> +0.3	V
Amp input and output voltage	$V_{AMP}$	-0.3 to V <sub>CC</sub> +0.3	V
Power dissipation 1	Pd1	880* <sup>1</sup>	mW
Power dissipation 2	Pd2	3260* <sup>2</sup>	mW
Power dissipation 3	Pd3	4560* <sup>3</sup>	mW
Junction temperature	Tjmax	150	°C
Storage temperature range	Tstg	-55 to +150	°C
VP power supply load current (DC)	I <sub>VPDC</sub>	-300 to +300*4	mA
VP power supply load current (peak*5)	I <sub>VPP</sub>	-500 to +500*4	mA
H-bridge output current (DC)	I <sub>OUT</sub>	-500 to +500*4	mA
H-bridge output current (peak 1*6)	I <sub>OUTP1</sub>	-1000 to +1000*4	mA
H-bridge output current (peak 2*7)	I <sub>OUTP2</sub>	-2000 to +2000*4	mA

 $<sup>^{\</sup>star 1}$  Reduced by 7.0mW /  $^{\circ}$ C , when mounted on a one layer glass epoxy board

#### Recommended Operating Ratings

Parameter	Symbol	Limit	Unit
Power supply voltage	V <sub>CC</sub>	2.7 to 3.6	V
VP power supply voltage	V <sub>P</sub>	4.0 to 27.0	V
SWO supply voltage	V <sub>SWO</sub>	4.0 to 27.0	V
Control input voltage	$V_{IN}$	0 to V <sub>CC</sub>	V
Amplifier input-output voltage	$V_{AMP}$	0 to V <sub>CC</sub>	V
INA, INB input frequency	F <sub>IN</sub>	0 to 300	kHz
SCLK frequency	S <sub>CL</sub>	0 to 5	MHz
Operating temperature range	T <sub>opr</sub>	-30 to 85	°C

<sup>\*</sup> VP supply voltage contains soft start mode (V<sub>P</sub> = 4V to 14V). VP voltage setting range is 14 to 25V.

<sup>\*\*</sup>Reduced by 7.0mW / °C , when mounted on a one layer glass epoxy board (74.2mm × 74.2mm × 1.6mm front and back radiation of heat copper foil 20.2mm², Ta=25°C)

\*\*2 Reduced by 26.0mW / °C , when mounted on a four layers glass epoxy board (74.2mm × 74.2mm × 1.6mm front and back radiation of heat copper foil 20.2mm², 2nd and 3nd radiation of heat copper foil 5505mm², Ta=25°C).

\*\*3 Reduced by 36.4mW / °C , when mounted on a four layers glass epoxy board (74.2mm × 74.2mm × 74.2mm x radiation of heat copper foil 5505mm², Ta=25°C).

 <sup>\*4</sup> Pd, ASO, and never exceed Tjmax=150°C.
 \*5 A peak electric current value after having smoothed by 20µF bypass condenser which is connected between VP and GND.

And which is drifted when the H-bridge works as Forward / Reverse.

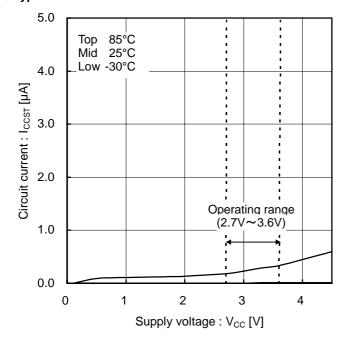
<sup>\*&</sup>lt;sup>6</sup> On time≦10µs and Duty≦30%.

<sup>\*&</sup>lt;sup>7</sup> On time≦5µs and Duty≦15%.

●Electrical Characteristics (Unless otherwise specified Ta=25°C, V<sub>CC</sub>=3.3V, VBAT=8V. V<sub>P</sub>=20V)

ectrical Characteristics (Unless otherwise specified Ta=25°C, V <sub>CC</sub> =3.3V, VBAT=8V, V <sub>P</sub> =20V)								
Parameter	Symbol		Limit		Unit	Conditions		
r arameter	Symbol	Min.	Тур.	Max.				
All circuits								
Circuit current during stand-by operation	I <sub>CCST</sub>	ı	0	1	μΑ	Stand-by mode PS=0V		
Circuit current	I <sub>CC</sub>	1.5	2.8	5.0	mA	Active mode PS =Hi,ERRIN= V <sub>CC</sub> , INP= V <sub>CC</sub> /2,INN=AMPOUT		
Control input (IN= PS, INA,	INB, SEN, S	CLK, SDAT	ГА)					
High-level input voltage	V <sub>INH</sub>	1.45	-	V <sub>CC</sub>	V			
Low-level input voltage	V <sub>INL</sub>	0	-	0.5	V			
High-level input current	I <sub>INH</sub>	15	30	60	μA	V <sub>IN</sub> =3V		
Low-level input current	I <sub>INL</sub>	-1	0	1	μA	V <sub>IN</sub> =0V		
Logic output (OUT=STATE)	ii.			1				
Hi output 0	H <sub>00</sub>	1.6	1.8	2.0	V	LSET=1'b0 no load mode		
Hi output 1	H <sub>O1</sub>	V <sub>CC</sub> -0.3	V <sub>CC</sub> -0.15	-	V	LSET=1'b1 0.5mA source condition		
Lo output	Lo	-	0.15	0.3	V	0.5mA sink condition		
Under voltage Locked out	(UVLO circu	it)		1	1			
UVLO voltage 1(VCC)	V <sub>UVLO1VCC</sub>	1.8	-	2.2	V	Serial data reset		
UVLO voltage 2(VCC)	V <sub>UVLO2VCC</sub>	2.25	-	2.65	V	SWO output, H bridge output, AMPOUT : OFF		
UVLO voltage difference 12(VCC)	V <sub>UVLOD12</sub> VCC	0.1	0.4	0.75	V	The difference voltage between each UVLO start voltage of Serial data set and out put OFF		
FULL ON driver block								
Output ON resistance	R <sub>ON</sub>	-	0.60	0.85	Ω	High-side and Low-side ON resistance total		
Turn On time 0	T <sub>on0</sub>	-	300	700	ns	TR=1'h0		
Turn On time 1	T <sub>on1</sub>	-	150	500	ns	TR=1'h1		
Turn Off time	T <sub>off0</sub>	-	50	400	ns	TR=1'hx		
Amp								
Common mode input voltage range	V <sub>LOPI</sub>	0.1	-	V <sub>CC</sub> -0.1	V	INP voltage input ,INN=AMPOUT (no load)		
Input bias current	I <sub>BI</sub>	-3	0	3	μA			
Output source current	Іон	2.5	-	-	mA	INP= V <sub>CC</sub> /2,INN=AMPOUT		
Output sink current	I <sub>OL</sub>	0.2	0.3	-	mA	INP= V <sub>CC</sub> /2,INN=AMPOUT		
Slew Rate	S <sub>R</sub>	0.7	1.5	-	V/µs	INP=1 to 2V (or 2 to 1V) input, INN=AMPOUT, reaction velocity		
GB width product	G <sub>B</sub>	1.0	3.0	-	MHz			
Over voltage protection	O <sub>VP</sub>	1.6	1.8	2.0	V	In case of AMPOVP=1'd1		
STEP UP DC/DC converter								
Output Nch. ON resistance	D <sub>CRON</sub>	-	0.20	0.50	Ω			
Oscillation frequency	D <sub>cosc</sub>	600	750	900	kHz			
Soft start	SS <sub>ST</sub>	4.26	5.33	6.40	ms	SSSET=3'd5		
Reference voltage 14	S <sub>V14</sub>	13.58	14.0	14.42	V	VPSET=5'd14		
Reference voltage 20	S <sub>V20</sub>	19.5	20.0	20.5	V	VPSET=5'd20		
Reference voltage 25	S <sub>V25</sub>	24.5	25.0	25.5	V	VPSET=5'd25		
Power Good	P <sub>G</sub>	83	90	97	%	(VP voltage after soft start completion)[V] x PG[%]		
Power Good hysteresis	P <sub>GHYS</sub>	63	70	77	%	(VP voltage after soft start completion)[V] x PGHYS[%]		
Current limit	D <sub>CLIM</sub>	2.0	3.6	-	Α	SWO current		

#### **●**Typical Performance Curves



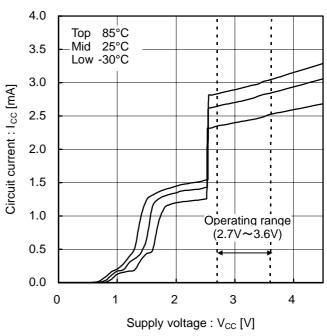
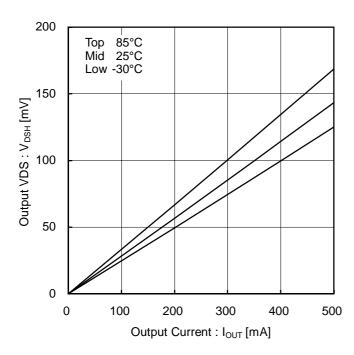


Figure 3. Stand-by mode circuit current

Figure 4. Circuit current



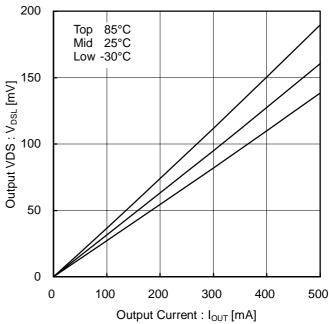


Figure 5. H-bridge output High-side ON resistance  $(V_P=20V, V_{CC}=3.3V)$ 

Figure 6. H-bridge output Low-side ON resistance  $(V_P=20V, V_{CC}=3.3V)$ 

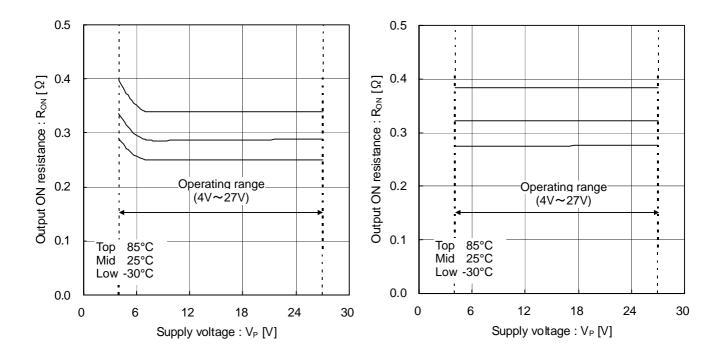


Figure 7. H-bridge output High-side ON resistance (VP dependency, VCC=3.3V)

Figure 8. H-bridge output Low-side ON resistance ( $V_P$  dependency,  $V_{CC}$ =3.3V)

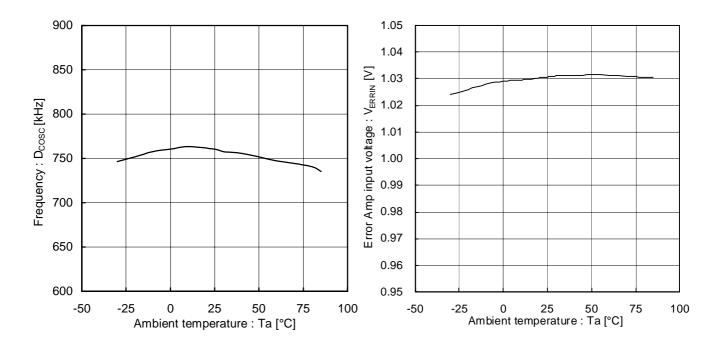


Figure 9. DC/DC switching frequency (Temperature dependency)

Figure 10. Error amplifier threshold voltage (Temperature dependency)

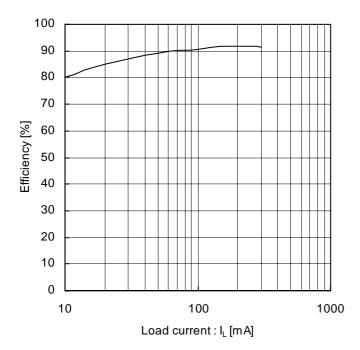


Figure 11. DC/DC power conversion efficiency (VBAT=6V,  $V_P$ =20V)

#### Function Description

(1) Rese
----------

Mode	PS terminal	CLCANCEL	cl	STATE terminal (STATESEL=3'd0)	SWO output	H-bridge output
Stand-by mode	L	0 (reset)	1	L	HiZ	HiZ
Circuit start up and the voltage boost start	H (after ic=1)	0	1	L	Normal	Normal
Condition that the voltage boost complete	Н	0	1	Н	Normal	Normal
In case that it takes UVLOVCC1 (Serial data set)	Н	0 (reset)	1	L	HiZ	HiZ
In the case that it takes UVLOVCC2 or TSD	Н	0	1	L	HiZ	HiZ
SWO current limit	Н	0	0	L	Latched in HiZ	Latched in HiZ
STATE terminal output Cl invalid	Н	1	1 (set)	Н	Normal or *8	Normal

- \* Regarding the return of UVLOVCC2 and TSD, The VP voltage setting DAC output soft starts from 0V.
- \* When it takes current limit three times consecutively in CLCANCEL=1'b0 , It stop the SWO output and H bridge output. As for the return of the current limit, it is reset the PS terminal. (refer to Figure 12).
- \*8 When the SWO output is ON, it does sense of an SWO output current. And when its value is more than current I Current limit, it makes SWO output HiZ. The movement in CLCANCEL=1'b1 is Figure 13.

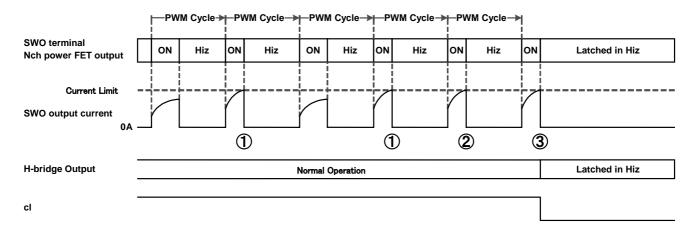


Figure 12. SWO output current limit timing chart

CLCANSEL=1'd0 cl Effective

Latched SWO and H-bridge in HiZ when the current limit detect three times consecutively

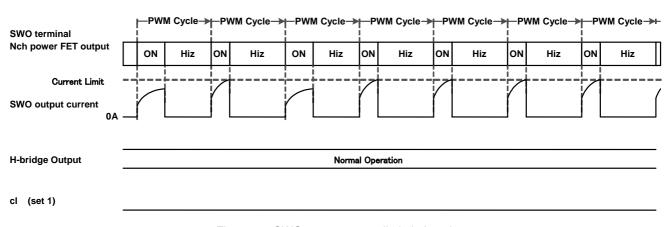


Figure 13. SWO output current limit timing chart CLCANCEL=1'd1 cl invalidity

#### (2) Logic output setting, STATE terminal output voltage

LSET	STATE terminal output
0	0 / 1.8V output
1	0 / V <sub>CC</sub> output

# (3) Selection of the internal output signal of STATE terminal

STATESEL =3'd	Signal name	Function
0	ic & Power Good & uvlovcc2 & tsd& (cl   CLCANCEL)	ic, Power Good, UVLOVCC2, TSD, (cl   CLCANCEL) .If any one of those signals is "0"(stand-by or abnormal condition) outputs Lo.
1	S_POWERGOOD & S_UVLOVCC2 & S_TSD & S_(cl   CLCANCEL)	S_ POWERGOOD, S_UVLOVCC2, S_TSD, S_(cl   CLCANCEL) If any one of those signals is "0"(stand-by or abnormal condition) outputs Lo.
2	ic	Normal circuit condition signal (In stand-by mode, it outputs Lo signal)
3	S_POWERGOOD	Power Good signal for the latch (Original signal is Power Good)
4	S_UVLOVCC2	VCCUVLO2 signal for the latch (Original signal is uvlovcc2) (In UVLO active mode, it outputs Lo signal)
5	-	-
6	S_TSD	Thermal shut down signal for the latch (Original signal is TSD) (In Thermal shutdown condition, it outputs Lo signal)
7	S_(cl   CLCANCEL)	Current limit signal for the latch (Original signal is (cl   CLCANCEL)

<sup>\* &</sup>quot;&" means AND logic. "|" means OR logic.

(4) STATE terminal output voltage setting

Mode	PS terminal	STATESET	S_POWER GOOD & S_UVLOVC C2 & S_TSD & S_(cl   CLCANCEL) STATESEL=3'	S_POWER GOOD STATESEL=3'	S_UVLOVC C2 STATESEL=3'	S_TSD STATESEL=3'	S_(cl   CLCANCEL) STATESEL=3' d7
Stand-by mode	L	0	L (reset)	L (reset)	L (reset)	L (reset)	L (reset)
V <sub>CC</sub> < V <sub>UVLO1VCC</sub> condition	Н	0	L (reset)	L (reset)	L (reset)	L (reset)	L (reset)
Circuit start up and the voltage boost start	H (after ic=1)	0	L	L	Н	Н	Н
Condition that the voltage boost complete	Н	0	L→H	L→H	Н	Н	Н
In the condition of Boost voltage<(setting 70%)	Н	0	H→L (latch)	H→L (latch)	H (fix)	H (fix)	H (fix)
In the case of V <sub>UVL01VCC</sub> < V <sub>CC</sub> < V <sub>UVL02VCC</sub>	Н	0	H→L (latch)	H (fix)	H→L (latch)	H (fix)	H (fix)
In the case of TSD	Н	0	H→L (latch)	H (fix)	H (fix)	H→L (latch)	H (fix)
In the case of CLCANCEL=1'b0 and Current limit condition	Н	0	H→L (latch)	H (fix)	H (fix)	H (fix)	H→L (latch)
In the condition of STATESET=1'b1	Н	1	H (set)	H (set)	H (set)	H (set)	H (set)

<sup>\*</sup> At the time of the falling edge of STATE terminal, it does latch the first changing signal from 1 to 0 in S\_POWERGOOD, S\_UVLOVCC2, S\_TSD, S\_(cl | CLCANCEL) and other signals are hold as 1.

<sup>\*</sup> At the time of a change VPSET[3:0] , it ignore the falling edge of the STATE terminal.

(5) Operation timing chart

Item	Symbol	Max.	Unit
$V_{\text{CC}} > V_{\text{UVLO1VCC}}$ and the time after(PS=Lo to Hi) until 3 wire communication	T <sub>EN</sub>	100	μs
Start up(PS=Lo to Hi) , $V_{CC} > V_{UVLO2VCC}$ and the time after the cancellation TSD until normal condition	T <sub>RETURN</sub>	100	μs

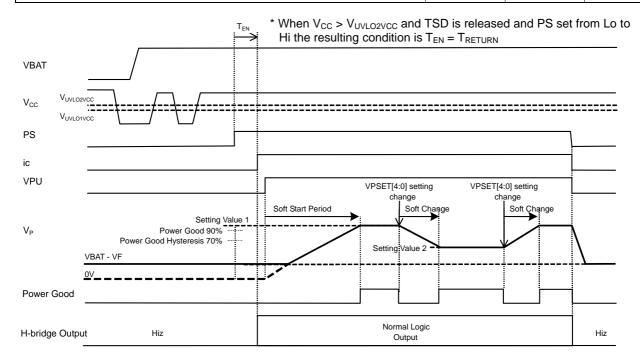


Figure 14. Start up and Stop sequence
\*The period of soft start and soft change is Power Good=1'b0(fix).
After soft start and soft change, 90% of setting value and Power Good=1'b1.
With hysteresis, it is 70% and Power Good=1'b0.

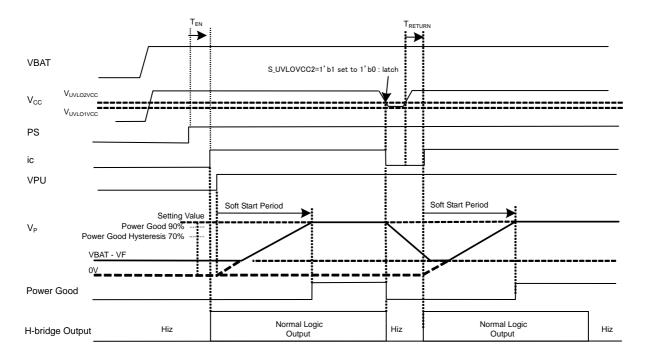


Figure 15. UVLOVCC2 (or TSD) operation and cancellation sequence

- (6) AMPOUT terminal over voltage protection circuit
- 1. Monitoring AMPOUT voltage, And when it reach more than 1.8V, it make Class-A Amp output Pch. CMOS(M1) OFF and stop the energy supply from VCC.
- 2. Because the constant current I is active, it decrease the voltage in high value of AMPOUT toward GND direction.
- 3. It returns when the voltage of AMPOUT is less than 1.8V(typ.)

AMPOVP	AMPOUT1.8V over voltage protection				
0	OFF (Default)				
1	ON				

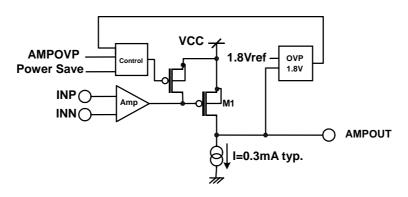


Figure 16. Over voltage protection circuit of AMP block

# (7) In the case of amplifier unused

Use with connecting INN = AMPOUT terminal, and INP = GND.

#### **●**Boost Converter Block Explanation

(1)Output voltage setting

	mage coming						
VPSET =5'd	VP voltage	VPSET =5'd	VP voltage	VPSET =5'd	VP voltage	VPSET =5'd	VP voltage
-	V	-	V	-	V	-	V
0	SWO HiZ	8		16	16	24	24
1		9		17	17	25	25
2		10	inhibited	18	18	26	
3		11	irinbited	19	19	27	
4	inhibited	12		20	20	28	inhihitad
5		13		21	21	29	inhibited
6		14	14	22	22	30	
7		15	15	23	23	31	

<sup>\*</sup> With the application circuit as Figure 1, V<sub>P</sub>=VBAT-VF when VPU=1'b0.

(2)Soft start / soft change setting

SSSET =4'd	Soft start setting	SSSET =4'd	Soft start setting
-	ms/25V	=	ms/25V
0	5.33(default)	8	8.53
1	1.07	9	9.60
2	2.13	10	10.67
3	3.20	11	11.73
4	4.27	12	12.80
5	5.33	13	13.87
6	6.40	14	14.93
7	7.47	15	16.00

<sup>\*</sup> Typical time between starting step up and finishing soft start at VPSET[4:0]=5'd25 (25V)setting.

Soft start time) = (VPSET setting voltage[V]) × (SSSET setting time[ms/25V]) / 25[V]

 $= 14[V] \times 5.33[ms/25V] / 25[V]$ 

= 2.98 ms

### (3) SWO switching speed control function

\* As considering efficiency and switching noise to VCC voltage supply, default setting value of PON and NON[1:0] are determined.

PON	<u> </u>	ordan coming value of the transmitter (1.0) are determined.		
=1'b	VCC side switching speed control	Comment		
-10				
0	P2 operate	default		
1	P3 operate	Use to reduce the noise at SWO turning ON		

NON =2'b	PGND side switching speed control	Comment
00	N1 operate	default
01	N2 operate	Use to reduce the noise at SWO turning OFF
1x	N3 operate	Use to reduce the noise at SWO turning OFF

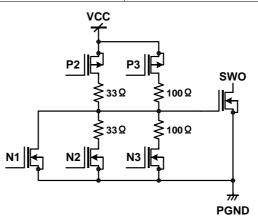


Figure 17. SWO circuit

Ex.) VPSET[4:0]=5'd14 (VP voltage is 14V setting), SSSET[3:0]=4'd5 (=5.33ms/25V)

#### (4) Power good filter function

Power good filter works when  $V_P$  drops lower than 70%(typ.) of VP setting voltage, and the filer is reset when VP voltage increase higher than 90%(typ.) of VP setting voltage. When  $V_P$  drops lower than 70% and it takes longer than 5.3ms (typ.) to recover, Power Good signal turns from Hi to Lo.

\* When PGFIL\_=1'b0(default), power good filter is enabled, and when PGFIL\_=1'b1, disabled.

Conditions Ta=25°C, V<sub>CC</sub>=3.3V

Itama		Units		
Items	Min.	Тур.	Max.	UTIILS
Power good filter time	4.2	5.3	6.4	ms

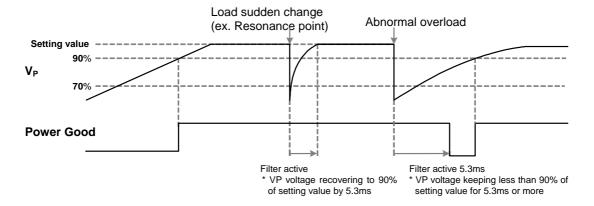


Figure 18. Power good filter timing chart PGFIL\_=1'b0(default) setting

#### (5) Over voltage protection

When VP voltage increase +15%(typ.) more than VP setting voltage(or indicated setting voltage in soft start / soft change time), OVP works and output of SWO turns to HiZ. OVP detect threshold voltage has hysteresis, and after OVP works when VP terminal voltage becomes under +10%(typ.) more than VP setting voltage, SWO switching restarts OVP function doesn't work when in stand-by state or VPU=1'b0.

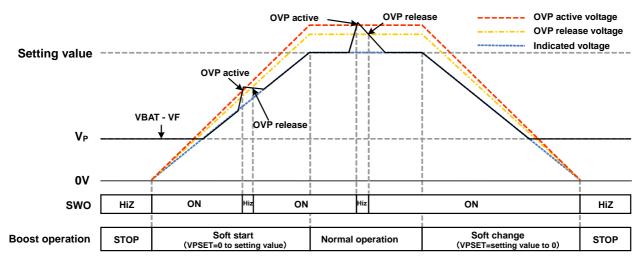


Figure 19. OVP function timing chart

# H-bridge Block

(1) H-bridge input and output truth table

(1) IT bridge input and output truth table								
Input		INF	UT			OUTPUT		
method	PS* <sup>9</sup>	MODE	INA	INB	OUTA	OUTB	Output mode	
	IN	0	L	X	L	L	Short brake	
EN/IN		(default)	Н	L	Н	L	Forward	
		(delault)	Н	Н	L	Н	Reverse	
	Н		L	L	Z	Z	Open(default)	
IN/IN		1	Н	L	Н	L	Forward	
IIN/IIN			L	Н	L	Н	Reverse	
			Н	H	L	L	Short brake	
-	L	X	X	X	Z	Z	Open	

# (2) Output switching speed

Condition Ta=25°C, V<sub>CC</sub>=3.3V, V<sub>P</sub>=20V, Load 100Ω Unit; ns

TR	Turn On Time (T <sub>ON</sub> )	Turn Off Time (T <sub>OFF</sub> )	Rise Time (T <sub>R</sub> )	Fall Time (T <sub>F</sub> )	Dead Time (Dead Time)
1'h0	300	50	350	20	80
1'h1	150	50	50	20	70

<sup>\*</sup> Dead Time in generated by internal timer.

<sup>\*</sup> Rise Time and Fall Time are defined by the ability of pre-driver of H-bridge.

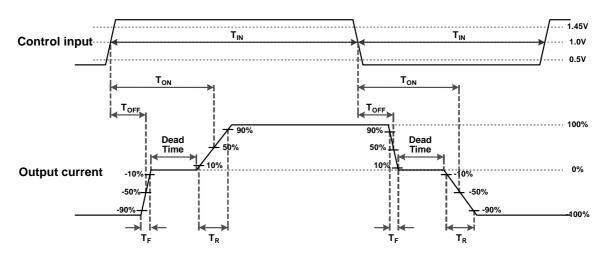


Figure 20. Definition of input-output AC characteristic

L; Low, H; High, X; Don't care, Z; Hi impedance

\*9 PS terminal input logic High; IC active condition, Low; IC stand-by condition

#### ●3-wired Serial

(1) 3-wired serial communication spec

Mode	PS	SEN	SCLK	SDATA
Stand-by mode	Lo	Input disable	Input disable	Input disable
Invalid communication mode	Hi	Hi	Input disable	Input disable
Write mode	Hi	Lo	SDATA latch in a rising edge	Data latch

<sup>\*</sup> Input SCLK=Lo when  $V_{CC} > V_{UVLO1VCC}$  or the time between start up (PS=Lo to Hi) and 3-wired serial communication (T<sub>EN</sub>).

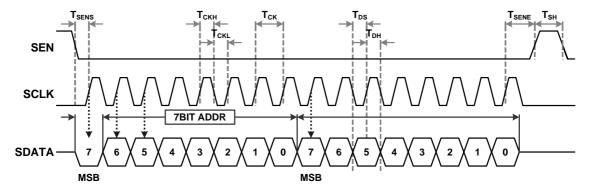


Figure 21. 3-wired serial communication

Item	Symbol	Min.	Unit
SCLK period	T <sub>CK</sub>	200	ns
SCLK high pulse width	T <sub>CKH</sub>	80	ns
SCLK low pulse width	T <sub>CKL</sub>	80	ns
SEN START set up time	T <sub>SENS</sub>	120	ns
SEN END set up time	T <sub>SENE</sub>	120	ns
STROBE high time	T <sub>SH</sub>	300	ns
DATA set up time (DATA of from SCLK falling to rising)	T <sub>DS</sub>	80	ns
DATA hold time (DATA of from SCLK rising to falling)	T <sub>DH</sub>	80	ns

(2) Register map

ADDR	W6	W5	W4	W3	W2	W1	W0	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	0	0	STATE SET	STATE SEL[2]	STATE SEL[1]	STATE SEL[0]	CLCAN CEL	MODE	LSET	VPU
1	0	0	0	0	0	0	1	PON	NON[1]	NON[0]	VPSET [4]	VPSET [3]	VPSET [2]	VPSET [1]	VPSET [0]
2	0	0	0	0	0	1	0	AMP OVP	TEST	TR	TEST	SSSET [3]	SSSET [2]	SSSET [1]	SSSET [0]
3	0	0	0	0	0	1	1	TEST	TEST	TEST	TEST	TEST	TEST	TEST	TEST
4	0	0	0	0	1	0	0	TEST	TEST	TEST	TEST	TEST	TEST	TEST	TEST
5	0	0	0	0	1	0	1	TEST	TEST	PGFIL_	TEST	TEST	TEST	TEST	TEST

<sup>\*</sup> All value of default value is 0. Stand-by condition (PS=Lo) or V<sub>CC</sub> < V<sub>UVLO1VCC</sub> condition does reset the data as the default And all bits are set as 0.

<sup>\*</sup> TEST Bits and other than address 0 to 2 should be set as 0(default) anytime.

(3) Serial register address use list

Address	Use
0	Boost start signal, Logic output signal setting, H-bridge output logic setting, STATE terminal output cl invalidity signal, STATE terminal output internal select signal setting, STATE terminal output set signal
1	Boost voltage setting, SWO switching speed setting
2	Soft start/Soft change setting, AMPOUT over voltage protection enable, Through rate control setting
3	TEST
4	TEST
5	Power good filter enable signal

#### (4) Serial register bit function list

Name	Function	Name	Function
VPU	Boost function start signal	LSET	Logic output voltage setting
MODE	H-bridge output logic setting	CLCANCEL	STATE terminal output c l invalid signal
STATESEL[2:0]	STATE terminal internal output signal select	STATESET	STATE terminal output setting signal
VPSET[4:0]	Boost circuit voltage setting	PON、NON[1:0]	SWO switching speed setting
SSSET[3:0]	Soft start / soft change setting	TR	Through rate control setting
AMPOVP	AMPOUT over voltage protection enable	PGFIL_	Power good filter enable signal
TEST	TEST data	-	-

# ●Power Dissipation

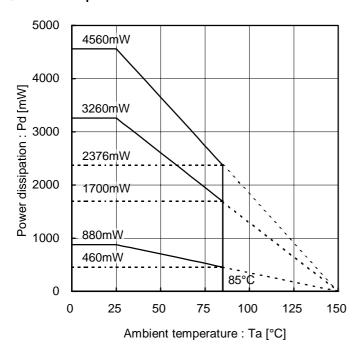


Figure 22. Package heat reduction characteristic

# ●I/O Equivalence Circuits

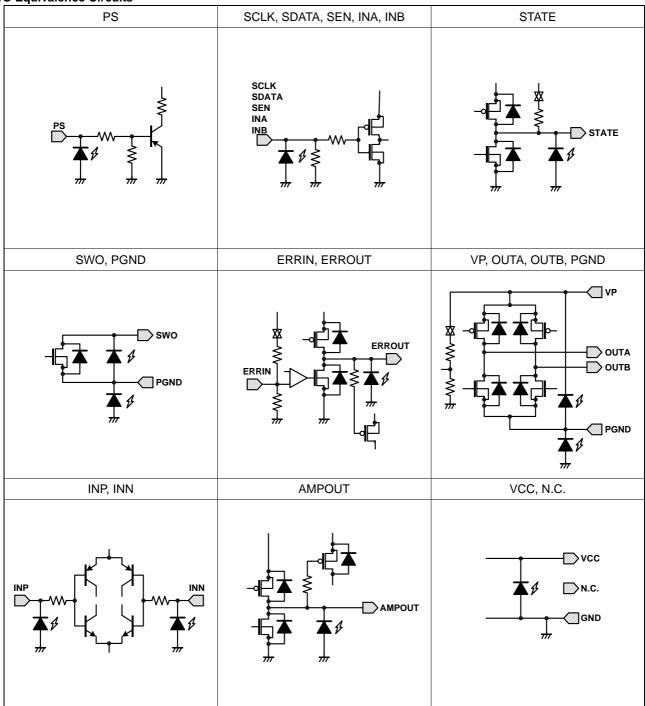


Figure 23. I/O equivalence circuit

#### Operational Notes

#### 1) Absolute maximum ratings

Use of the IC in excess of absolute maximum ratings such as the applied voltage or operating temperature range may result in IC damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is suffered. The implementation of a physical safety measure such as a fuse should be considered when use of the IC in a special mode where the absolute maximum ratings may be exceeded is anticipated.

#### 2) Power supply pins and lines

None of the VP line for the H-bridges is internally connected to the VCC power supply line, which is only for the control logic or analog circuit. Therefore, the VP and VCC lines can be driven at different voltages. Although these lines can be connected to a common power supply, do not open the power supply pin but connect it to the power supply externally. Regenerated current may flow as a result of the motor's back electromotive force. Insert capacitors between the power supply and ground pins to serve as a route for regenerated current. Determine the capacitance in full consideration of all the characteristics of the electrolytic capacitor, because the electrolytic capacitor may loose some capacitance at low temperatures. If the connected power supply does not have sufficient current absorption capacity, regenerative current will cause the voltage on the power supply line to rise, which combined with the product and its peripheral circuitry may exceed the absolute maximum ratings. It is recommended to implement a physical safety measure such as the insertion of a voltage clamp diode between the power supply and ground pins.

For this IC with several power supplies and a part consists of the CMOS block, it is possible that rush current may flow instantaneously due to the internal powering sequence and delays, and to the unstable internal logic, respectively. Therefore, give special consideration to power coupling capacitance, width of power and ground wirings, and routing of wiring.

#### 3) Ground pins and lines

Ensure a minimum GND pin potential in all operating conditions. Make sure that no pins are at a voltage below the GND at any time, regardless of whether it is a transient signal or not.

When using both small signal GND and large current PGND patterns, it is recommended to isolate the two ground patterns, placing a single ground point at the application's reference point so that the pattern wiring resistance and voltage variations caused by large currents do not cause variations in the small signal ground voltage. Be careful not to change the GND wiring pattern of any external components, either.

The power supply and ground lines must be as short and thick as possible to reduce line impedance.

#### 4) Thermal design

Use a thermal design that allows for a sufficient margin in light of the power dissipation (Pd) in actual operating conditions.

# 5) Actions in strong magnetic field

Use caution when using the IC in the presence of a strong magnetic field as doing so may cause the IC to malfunction.

#### 6) ASO

When using the IC, set the output transistor for the motor so that it does not exceed absolute maximum ratings or ASO.

#### 7) Thermal shutdown circuit

This IC incorporates a TSD (thermal shutdown) circuit. If the temperature of the chip reaches the following temperature, the motor coil output will be opened. The TSD circuit is designed only to shut the IC off to prevent runaway thermal operation. It is not designed to protect the IC or guarantee its operation. Do not continue to use the IC after operating this circuit or use the IC in an environment where the operation of this circuit is assumed.

TSD ON temperature [°C] (Typ.)	Hysteresis temperature [°C] (Typ.)		
175	20		

 After releasing Under Voltage Locked Out (UVLO) or Thermal Shut Down (TSD) When UVLO, TSD is released, it returns normal operation after 100µs (max).

#### 9) VBAT external power supply

This IC is not equipped with terminal of VBAT, and operate even the VBAT external power supply is lower than 4V (minimum VP operation voltage). Give consideration that if VBAT external power supply is low and VP setting voltage is high or load is large, may cause an overcurrent flowing through SWO terminal, and may enable OCP, TSD, etc. In addition, if the VBAT external power supply has changed during the boost operation (ex. VBAT=HiZ), because of boosting VP to setting voltage without working soft start / soft change, may cause overcurrent flowing through SWO terminal. If VBAT external power supply is changing, stop boost operation by setting PS=0V or VPU=1'b0, then set the soft start function after VBAT power supply voltage is stable.

#### 10) N.C. pin

Always keep N.C. pin open.

#### 11) Application example

The application circuit is recommended for use. Make sure to confirm the adequacy of the characteristics. When using the circuit with changes to the external circuit constants, make sure to leave an adequate margin for external components including static and transitional characteristics as well as dispersion of the IC.

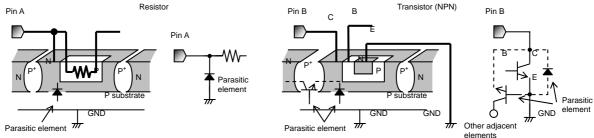


Figure 24. Example of Simple IC Architecture

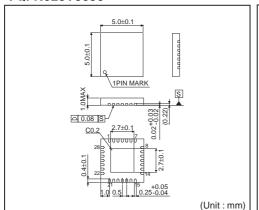
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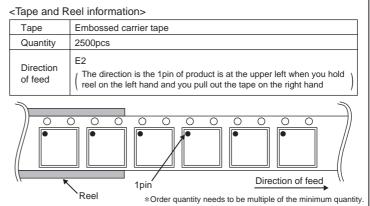
The Japanese version of this document is formal specification. A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document formal version takes priority

# ● Physical Dimension, Tape and Reel Information

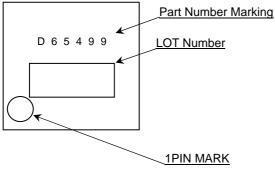
#### VQFN028V5050





# Marking Diagram

# VQFN028V5050 (TOP VIEW)



# Revision History

Date	Revision	Changes		
3.Aug.2012	001	New Release		

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CLASSIV		CLASSⅢ	

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
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  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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